





HIGH SENSITIVITY HALL EFFECT LATCH

Description

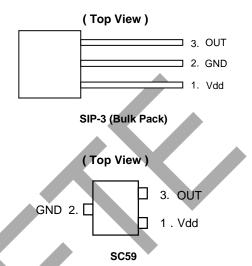
The AH3761 is an integrated Hall effect latched sensor designed for electronic commutation of brush-less DC motor applications. The device includes an on-chip Hall voltage generator for magnetic sensing, a comparator that amplifies the Hall voltage, and a Schmitt trigger to provide switching hysteresis for noise rejection, and open drain output. An internal bandgap regulator is used to provide temperature compensated supply voltage for internal circuits and allows a wide operating supply range.

If a magnetic flux density larger than threshold Bop, DO is turned on (low). The output state is held until a magnetic flux density reversal falls below Brp causing DO to be turned off (high).

Features

- 3V to 28V DC Operation Voltage
- Chopper Stabilized
- Wide Operating Voltage Range
- **Built-in Power Reverse Protection**
- **Built-in Voltage Overshoot Protection**
- **Output Short Circuit Protection**
- Open Drain Pre-Driver
- SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) and SC59 (Commonly known as SOT23 in Asia)
- Available in "Green" Molding Compound (No Br. Sb)
- Totally Lead-Free & Fully RoHS Compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Pin Assignments



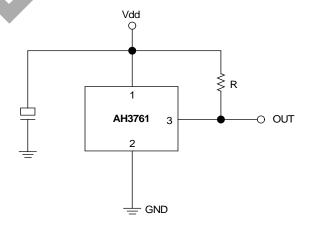
Applications

- **Brushless DC Motor Commutation**
- RPM Detection
- Consumer and Industrial Position Sensor
- Flow Meters

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Typical Applications Circuit

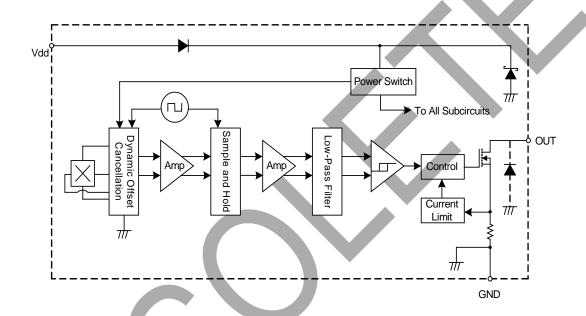




Pin Descriptions

| Pin Name | P/I/O | Pin# | Description |
|----------|-------|------|-----------------------|
| Vdd | Р | 1 | Positive Power Supply |
| GND | Р | 2 | Ground |
| OUT | 0 | 3 | Output Pin |

Functional Block Diagram



Absolute Maximum Ratings (TA = +25°C)

| Symbol | Characterist | içs | Values | Unit |
|----------------------|-------------------------------------|---|-------------|------|
| V_{DD} | Supply Voltage | | 30 | V |
| V_{RDD} | Reverse Battery Voltage | | -30 | V |
| В | Magnetic Flux Density | | Unlimited | |
| V _D S | Output OFF Voltage | | 30 | V |
| I _{O(peak)} | Output "On" Current (Peak) | | 100 | mA |
| T _{ST} | Storage Temperature Range | | -65 to +150 | °C |
| T _J (MAX) | Maximum Junction Temperature | | +150 | °C |
| PD | Package Power Dissipation | SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) | 550 | mW |
| | | SC59 | 230 | mW |
| θις | Thermal Resistance Junction to case | SIP-3 (Ammo Pack), SIP-3 (Bulk Pack) | 227 | °C/W |
| | | SC59 | 543 | °C/W |



Recommended Operating Conditions

| Symbol | Characteristic | Conditions | Min | Тур. | Max | Unit |
|----------------|-------------------------------|------------|-----|------|------|------|
| V_{DD} | Supply Voltage | Operating | 3 | 24 | 28 | V |
| T _A | Operating Ambient Temperature | Operating | -40 | | +125 | °C |

Electrical Characteristics (T_A = +25°C, V_{DD} =24V, Note 4)

| Symbol | Characteristic | Test Conditions | Min | Тур. | Max | Unit |
|---------------------|---------------------------|---|-----|-------|-----|------|
| V _{O(SAT)} | Output Saturation Voltage | lout =20mA, B>Bop | - | 300 | 500 | mV |
| l _{OFF} | Output Leakage Current | V _O =24V, B <bop< td=""><td>-</td><td>< 0.1</td><td>10</td><td>μΑ</td></bop<> | - | < 0.1 | 10 | μΑ |
| I _{DD} | Supply Current | Output Open | 4- | 4 | 6 | mA |
| t _R | Output Rising Time | $R_L = 10k\Omega$, $C_L = 16pF$ | - | 340 | - | ns |
| t _F | Output Falling Time | $R_L = 10k\Omega$, $C_L = 16pF$ | - | 20 | - | ns |
| f _C | Chopping Frequency | - | - | 300 | - | kHz |
| Іом | Output Current Limit | B>Bop (Note 5) | 50 | 70 | 90 | mA |
| tsT | Start-up time of IC | V _{DD} >3V, B>Bop (Note 6) | - | 47 | - | μs |

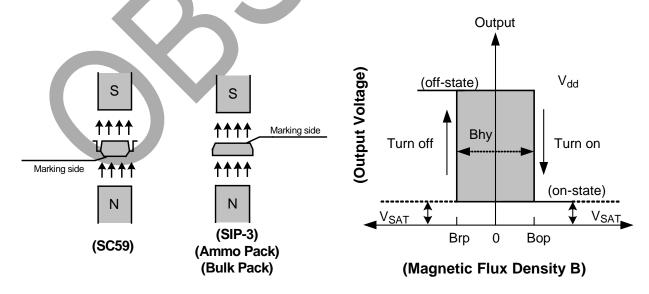
Notes:

- 4. Typical data is at T_A =+25°C, V_{DD} =24V and is design information only.
- 5. The device will shut down operating after the output current I_O is over the output current limit I_{OM} for 160µs (typically). The device will re-start up operating after resetting the supply voltage V_{DD}.
- 6. In initial power on time, the output state is kept in "High" in this start-up time of IC.

Magnetic Characteristics (T_A = +25°C, V_{DD} =3V to 28V, Note 7)

| | | | | (| mii=i0Gauss) |
|--------|---------------|-----|------|-----|--------------|
| Symbol | Parameter | Min | Тур. | Max | Unit |
| Вор | Operate Point | 5 | 30 | 60 | Gauss |
| Brp | Release Point | -60 | -30 | -5 | Gauss |
| Bhys | Hysteresis | - | 60 | - | Gauss |

Notes: 7. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.



(1mT 10Course)



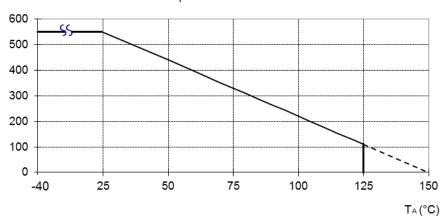
Performance Characteristics

(1) SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)

| T _A (°C) | 25 | 50 | 60 | 70 | 80 | 85 | 90 | 95 | 100 |
|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| P _D (mW) | 550 | 440 | 396 | 352 | 308 | 286 | 264 | 242 | 220 |
| T _A (°C) | 105 | 110 | 115 | 120 | 125 | 130 | 135 | 140 | 150 |
| P _D (mW) | 198 | 176 | 154 | 132 | 110 | 88 | 66 | 44 | 0 |

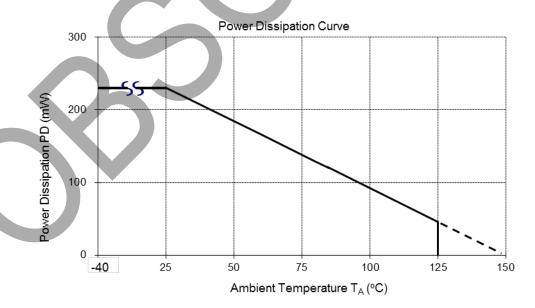


Power Dissipation Curve



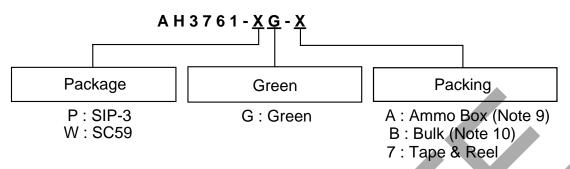
(2) SC59 (Commonly known as SOT23 in Asia)

| T _A (°C) | 25 | 50 | 60 | 70 | 80 | 90 | 100 | 110 | 120 | 125 | 130 | 140 | 150 |
|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| P _D (mW) | 230 | 184 | 166 | 147 | 129 | 110 | 92 | 74 | 55 | 46 | 37 | 18 | 0 |





Ordering Information



| | | | | Bu | ılk | 7" Tape | and Reel | Amm | о Вох |
|-------------|---------------------|-----------------|-----------------------|----------|--------------------------|---------------------|--------------------------|----------|--------------------------|
| Device | Status (Note 11) | Package Code | Packaging (Note 8) | Quantity | Part Number Suffix | Quantity | Part Number Suffix | Quantity | Part Number Suffix |
| AH3761-PG-A | EOL | Р | SIP-3(Ammo Pack) | NA | NA | NA | NA | 4000/Box | -A |
| AH3761-PG-B | NRND | Р | SIP-3(Bulk Pack) | 1000 | -B | NA | NA | NA | NA |
| AH3761-WG-7 | NRND | W | SC59 | NA | NA | 3000/Tape & Reel | -7 | NA | NA |

Notes:

- 8. Pad layout as shown on Diodes Incorporated's suggested pad layout document, which can be found on our website at http://www.diodes.com/package-outlines.html.

 9. Ammo Box is for SIP-3 Spread Lead.

 10. Bulk is for SIP-3 Straight Lead.

 11. NRND = Not Recommended for New Design.

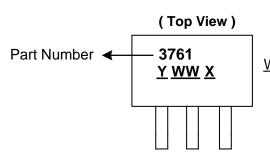
 EOL = End of Life.





Marking Information

(1) Package Type: SIP-3 (Ammo Pack), SIP-3 (Bulk Pack)



Y: Year: 0~9

<u>WW</u>: Week: 01~52, "52" represents

52 and 53 week

X: Internal Code: A~Z: Green

| Part Number | Package | Identification Code |
|-------------|-------------------|---------------------|
| AH3761 | SIP-3 (Ammo Pack) | 3761 |
| AH3761 | SIP-3 (Bulk Pack) | 3761 |

(2) Package Type: SC59



XX YWX

 \underline{XX} : Identification code \underline{Y} : Year 0~9

<u>W</u>: Week: A~Z: 1~26 week;

a~z : 27~52 week; z represents

52 and 53 week X: A~Z: Green

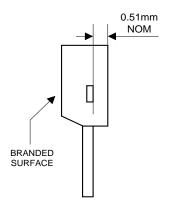
| Part Number | Package | Identification Code |
|-------------|---------|---------------------|
| AH3761 | SC59 | P8 |



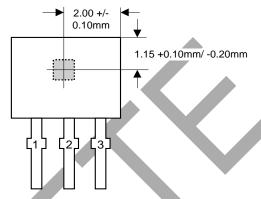
Package Outline Dimensions (All Dimensions in mm)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SIP-3 (Bulk Pack)

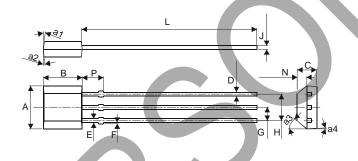


Active Area Depth



Sensor Location

Package Dimension



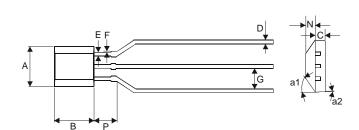
| | SIP-3 | | | | | |
|----------------------|-------|------------------|--|--|--|--|
| (Bulk Pack) | | | | | | |
| Dim | Min | Max | | | | |
| Α | 3.9 | 4.3 | | | | |
| a1 | 5 | □ур | | | | |
| a2 | 5 | □Ту | | | | |
| a3 | 45 | □ T ₂ | | | | |
| a4 | 3 | □Ту | | | | |
| В | 2.8 | 3.2 | | | | |
| С | 1.40 | 1.60 | | | | |
| D | 0.33 | 0.432 | | | | |
| E | 0.40 | 0.508 | | | | |
| F | 0 | 0.2 | | | | |
| G | 1.24 | 1.30 | | | | |
| Н | 2.51 | 2.57 | | | | |
| J | 0.35 | 0.43 | | | | |
| L | 14.0 | 15.0 | | | | |
| N | 0.63 | 0.84 | | | | |
| Р | 1.55 | - | | | | |
| All Dimensions in mm | | | | | | |



Package Outline Dimensions (Cont.)

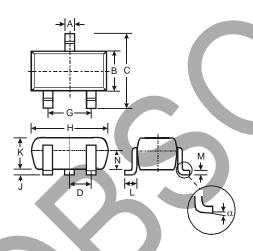
Please see http://www.diodes.com/package-outlines.html for the latest version.

(2) Package Type: SIP-3 (Ammo Pack)

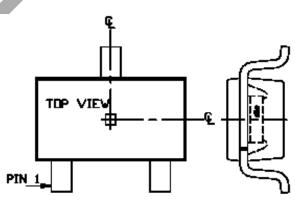


| | SIP-3 | | | | | | |
|----------|-------------|---------|--|--|--|--|--|
| (/ | (Ammo Pack) | | | | | | |
| Dim | Min | Max | | | | | |
| Α | 3.9 | 4.3 | | | | | |
| a1 | 45 | ☐ Ty | | | | | |
| a2 | 3 | ПТу | | | | | |
| В | 2.8 | 3.2 | | | | | |
| С | 1.40 | 1.□0 | | | | | |
| | 0□35 | 0.41 | | | | | |
| Е | 0.43 | 0.48 | | | | | |
| F | 0 | 0.2 | | | | | |
| G | 2.4 | 2.9 | | | | | |
| N | 0.63 | 0.84 | | | | | |
| P 1.55 - | | | | | | | |
| All Di | mension | s in mm | | | | | |

(3) Package Type: SC59



| SC59 | | | | |
|----------------------|-------|------|------|--|
| Dim | Min | Max | Тур | |
| Α | 0.35 | 0.50 | 0.38 | |
| В | 1.50 | 1.70 | 1.60 | |
| С | 2.70 | 3.00 | 2.80 | |
| D | - | - | 0.95 | |
| G | - | - | 1.90 | |
| Н | 2.90 | 3.10 | 3.00 | |
| J | 0.013 | 0.10 | 0.05 | |
| K | 1.00 | 1.30 | 1.10 | |
| L | 0.35 | 0.55 | 0.40 | |
| M | 0.10 | 0.20 | 0.15 | |
| N | 0.70 | 0.80 | 0.75 | |
| | 0° | 8° | - | |
| All Dimensions in mm | | | | |



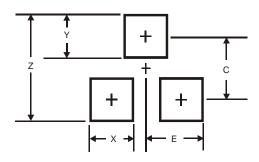
G=Package Center Line



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SC59



| Dimensions | Value (in mm) | |
|------------|------------------|--|
| Z | 3.4 | |
| Х | 0.8 | |
| Υ | 1.0 | |
| С | 2.4 | |
| | A 1 2E | |



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

This document is written in English but may be translated into multiple languages for reference. Only the English version of this document is the final and determinative format released by Diodes Incorporated.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2019, Diodes Incorporated

www.diodes.com

AH3761
Document number: DS31977 Rev. 3 - 4

单击下面可查看定价,库存,交付和生命周期等信息

>>Diodes Incorporated(达尔科技)